

SUN106012

New Generation N-Ch Power MOSFET

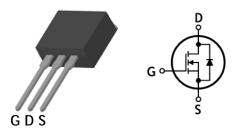
HIGH SPEED SWITCHING APPLICATION

Features

- Low drain-source On resistance: $R_{DS(on)}=0.6\Omega$ (Typ.)
- Low gate charge: Q_g=27nC (Typ.)
- Low reverse transfer capacitance: C_{rss}=4.9pF (Typ.)
- RoHS compliant device
- 100% avalanche tested

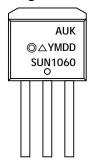
Ordering Information

| Part Number | Marking | Package |
|-------------|---------|---------|
| SUN1060I2 | SUN1060 | I2-PAK |



12-PAK

Marking Information



Column 1: Manufacturer

Column 2: Production Information

e.g.) ⊚△YMDD

-. O: Option Code (H: Halogen Free)

-. △: Factory Management Code

-. YMDD: Date Code (Year, Month, Date)

Column 3: Device Code

Absolute maximum ratings (T_C=25°C unless otherwise noted)

| Characteristic | | Symbol | Rating | Unit |
|---------------------------------------|------------------|-----------------------|---------|------|
| Drain-source voltage | | V _{DSS} | 600 | V |
| Gate-source voltage | | V_{GSS} | ±30 | V |
| Drain current (DC) * | I _D | T _c =25°C | 10 | А |
| Drain current (DC) | | T _c =100°C | 6.32 | А |
| Drain current (Pulsed) * | | I _{DM} | 40 | А |
| Single avalanche energy (Note 2) | E _{AS} | | 545 | mJ |
| Repetitive avalanche current (Note 1) | | I _{AR} | 10 | А |
| Repetitive avalanche energy (Note 1) | | E _{AR} | 11 | mJ |
| Power dissipation | | P _D | 110 | W |
| Junction temperature | | TJ | 150 | °C |
| Storage temperature range | T _{stg} | | -55~150 | °C |

^{*} Limited only maximum junction temperature

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Thermal Characteristics

| Characteristic | Symbol | Rating | Unit |
|---|---------------|-----------|------|
| Thermal resistance, junction to case | $R_{th(j-c)}$ | Max. 1.13 | °C/W |
| Thermal resistance, junction to ambient | $R_{th(j-a)}$ | Max. 50 | |

Electrical Characteristics (T_C=25°C unless otherwise noted)

| Characteristic | Symbol | Test Condition | Min. | Тур. | Max. | Unit |
|---------------------------------------|---------------------|---|------|------|------|------|
| Drain-source breakdown voltage | BV _{DSS} | I _D =250uA, V _{GS} =0 | 600 | - | - | V |
| Gate threshold voltage | $V_{GS(th)}$ | $I_D=250uA$, $V_{DS}=V_{GS}$ | 3 | - | 5 | V |
| | | V _{DS} =600V, V _{GS} =0V | - | - | 1 | uA |
| Drain-source cut-off current | I _{DSS} | V _{DS} =600V, T _c =150°C | - | - | 100 | uA |
| Gate leakage current | I _{GSS} | V_{DS} =0V, V_{GS} =±30V | - | - | ±100 | nA |
| Drain-source on-resistance | R _{DS(ON)} | V _{GS} =10V, I _D =5A | - | 0.6 | 0.75 | Ω |
| Forward transfer conductance (Note 3) | g _{fs} | V_{DS} =10V, I_D =5A | - | 11 | - | S |
| Input capacitance | C _{iss} | V _{DS} =25V, V _{GS} =0V, f=1.0MHz | - | 2178 | - | pF |
| Output capacitance | C _{oss} | | - | 154 | - | |
| Reverse transfer capacitance | C _{rss} | | - | 4.9 | - | |
| Turn-on delay time (Note 3,4) | t _{d(on)} | $V_{DS} = 300V, I_D = 10A, R_G = 25\Omega$ | - | 92 | - | |
| Rise time (Note 3,4) | t _r | | - | 40 | - | |
| Turn-off delay time (Note 3,4) | t _{d(off)} | | - | 175 | - | ns |
| Fall time (Note 3,4) | t _f | | - | 40 | - | |
| Total gate charge (Note 3,4) | Q_g | V _{DS} =480V, V _{GS} =10V, I _D =10A | - | 27 | 35 | |
| Gate-source charge (Note 3,4) | Q_{gs} | | - | 11 | - | nC |
| Gate-drain charge (Note 3,4) | Q_{gd} | | - | 5 | - | |

Source-Drain Diode Ratings and Characteristics (T_C=25°C unless otherwise noted)

| Characteristic | Symbol | Test Condition | Min. | Тур. | Max. | Unit |
|------------------------------------|-----------------|--|------|------|------|------|
| Source current (DC) | Is | Integral reverse diode | - | - | 10 | Α |
| Source current (Pulsed) | I _{SM} | in the MOSFET | - | - | 40 | Α |
| Forward voltage | V_{SD} | V _{GS} =0V, I _{SD} =10A | - | - | 1.4 | V |
| Reverse recovery time (Note 3,4) | t _{rr} | I _{SD} =10A, V _{GS} =0V dI _F /dt=100A/us | - | 467 | - | ns |
| Reverse recovery charge (Note 3,4) | Q _{rr} | | - | 2.85 | - | uC |

Note:

- 1. Repeated rating: Pulse width limited by safe operating area
- 2. L=10mH, I_{AS} =10A, V_{DD} =50V, R_{G} =25 Ω , Starting T_{J} =25 $^{\circ}$ C
- 3. Pulse test: Pulse width≤300us, Duty cycle≤2%
- 4. Essentially independent of operating temperature typical characteristics

Typical Electrical Characteristics Curves

Fig. 1 Typical Output Characteristics

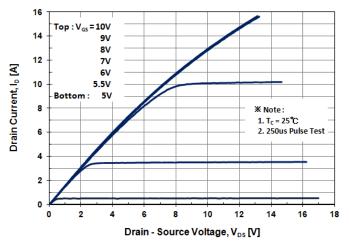


Fig. 2 Typical Output Characteristics

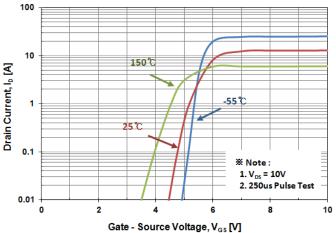


Fig.3 On-Resistance Variation with Drain Current and Gate Voltage

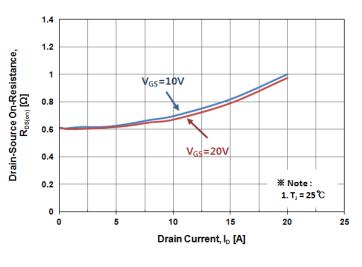


Fig. 4 Body Diode Forward Voltage Variation with Source Current

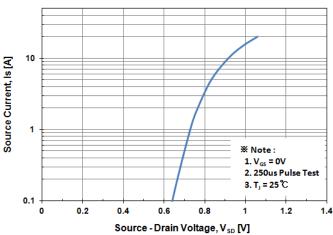


Fig. 5 Typical Capacitance Characteristics

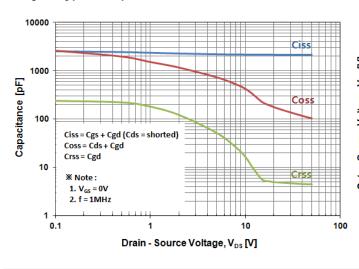
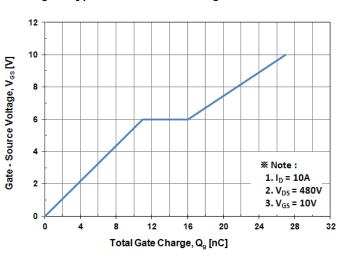


Fig. 6 Typical Total Gate Charge Characteristics



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Fig. 7 Breakdown Voltage Variation vs. Temperature

Fig. 8 On-Resistance Variation vs. Temperature

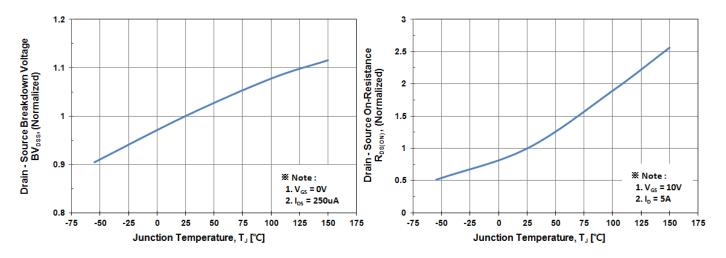


Fig. 9 Maximum Drain Current vs. Case Temperature

Fig. 10 Maximum Safe Operating Area

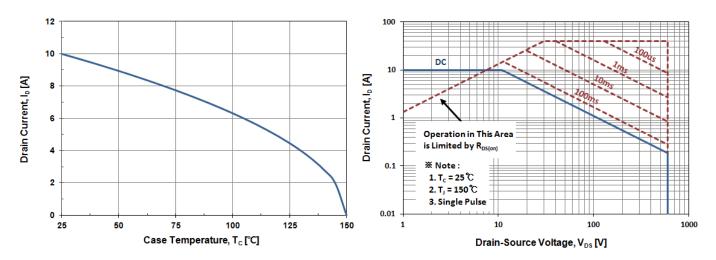
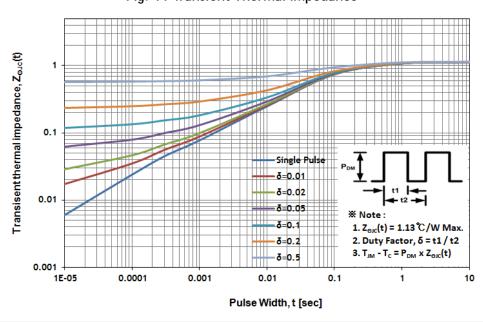
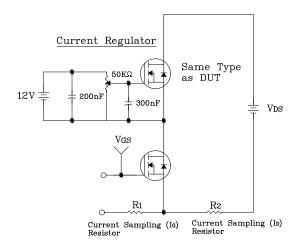


Fig. 11 Transient Thermal Impedance



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Fig. 12 Gate Charge Test Circuit & Waveform



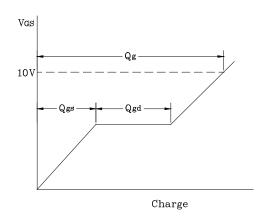
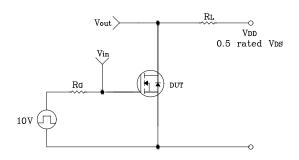


Fig. 13 Resistive Switching Test Circuit & Waveform



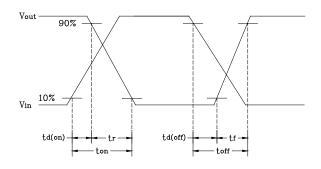
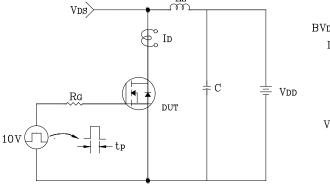


Fig. 14 E_{AS} Test Circuit & Waveform



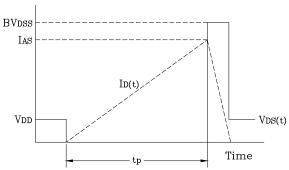
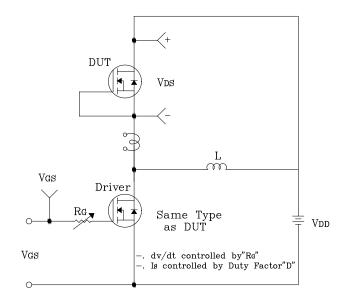
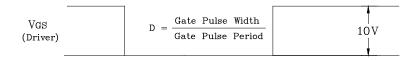
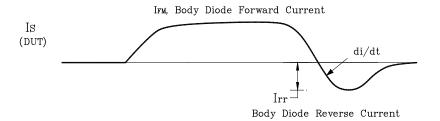
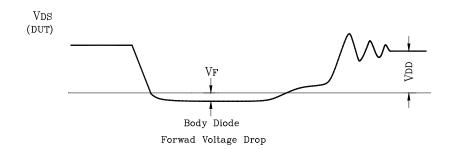


Fig. 15 Diode Reverse Recovery Time Test Circuit & Waveform

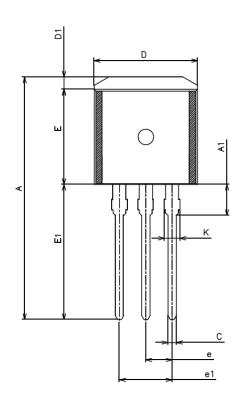


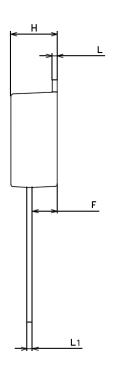


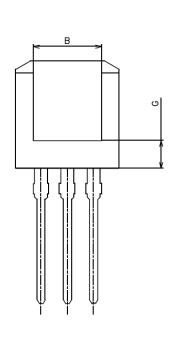




Package Outline Dimensions







| SYMBOL | 1 | NOTE | | |
|--------|---------|---------|---------|------|
| STMBOL | MINIMUM | NOMINAL | MAXIMUM | NOIL |
| Α | 22.98 | 23.48 | 23.98 | |
| A1 | 2.80 | 3.00 | 3.20 | |
| В | 6.40 | 6.60 | 6.80 | |
| С | 0.60 | 0.80 | 1.00 | |
| D | 9.80 | 10.00 | 10.20 | |
| D1 | 1.00 | 1.20 | 1.40 | |
| E | 9.05 | 9.20 | 9.35 | |
| E1 | 12.68 | 13.08 | 13.48 | |
| е | 2.34 | 2.54 | 2.74 | |
| e1 | 4.88 | 5.08 | 5.28 | |
| F | 2.20 | 2.40 | 2.60 | |
| G | 2.50 | 2.70 | 2.90 | |
| Н | 4.35 | 4.50 | 4.65 | |
| K | 1.42 | 1.52 | 1.62 | |
| L | 0.40 | 0.50 | 0.60 | |
| L1 | 0.40 | 0.50 | 0.60 | |

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